

**SOP-8 Dual P Enhancement 双P沟道增强型  
MOS Field Effect Transistor 场效应管**
**■ Features 特点**

Low on-resistance 低导通电阻

$R_{DS(ON)}=15\text{m}\Omega$ (Type)@ $V_{GS}=-10\text{V}$

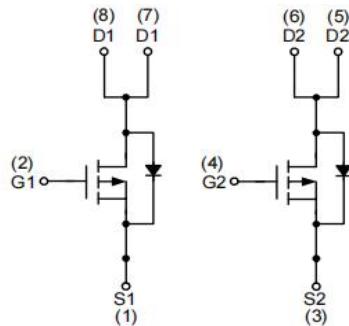
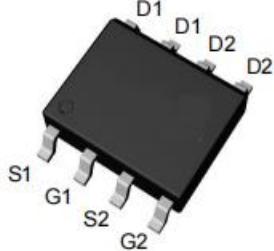
$R_{DS(ON)}=22\text{m}\Omega$ (Type)@ $V_{GS}=-4.5\text{V}$

**■ Applications 应用**

Power Management in Notebook Computer 笔记本电脑电源管理

Battery Powered Systems 电池电源系统

Portable Equipment 桌面设备

**■ Internal Schematic Diagram 内部结构**

**■ Absolute Maximum Ratings 最大额定值**

Characteristic 特性参数	Symbol 符号	Rating 额定值	Unit 单位
Drain-Source Voltage 漏极-源极电压	$BV_{DSS}$	-30	V
Gate- Source Voltage 栅极-源极电压	$V_{GS}$	$\pm 20$	V
Drain Current (continuous)漏极电流-连续	$I_D$ (at $T_A = 25^\circ\text{C}$ at $T_A = 70^\circ\text{C}$ )	-8.9 -7.1	A
Drain Current (pulsed)漏极电流-脉冲	$I_{DM}$	-35	A
Total Device Dissipation 总耗散功率	$P_{TOT}$ (at $T_A = 25^\circ\text{C}$ at $T_A = 70^\circ\text{C}$ )	2.5 1.6	W
Thermal Resistance Junction-Ambient 热阻	$R_{\theta JA}$	50	$^\circ\text{C}/\text{W}$
Avalanche Energy Single Pulse 雪崩能量	$E_{AS}$	29	mJ
Junction/Storage Temperature 结温/储存温度	$T_J, T_{stg}$	-55~150	$^\circ\text{C}$

## ■ Electrical Characteristics 电特性

(T<sub>A</sub>=25°C unless otherwise noted 如无特殊说明，温度为 25°C)

Characteristic 特性参数	Symbol 符号	Min 最小值	Typ 典型值	Max 最大值	Unit 单位
Drain-Source Breakdown Voltage 漏极-源极击穿电压(I <sub>D</sub> = -250uA, V <sub>GS</sub> =0V)	BV <sub>DSS</sub>	-30	—	—	V
Gate Threshold Voltage 栅极开启电压(I <sub>D</sub> = -250uA, V <sub>GS</sub> = V <sub>DS</sub> )	V <sub>GS(th)</sub>	-1.3	-1.8	-2.3	V
Zero Gate Voltage Drain Current 零栅压漏极电流(V <sub>GS</sub> =0V, V <sub>DS</sub> = -24V)	I <sub>DSS</sub>	—	—	-1	uA
Gate Body Leakage 栅极漏电流(V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V)	I <sub>GSS</sub>	—	—	±100	nA
Static Drain-Source On-State Resistance 静态漏源导通电阻(I <sub>D</sub> = -8.9A, V <sub>GS</sub> = -10V) (I <sub>D</sub> = -5.6A, V <sub>GS</sub> = -4.5V)	R <sub>DSS(ON)</sub>	—	15 22	21 30	mΩ
Diode Forward Voltage Drop 内附二极管正向压降(I <sub>SD</sub> = -1A, V <sub>GS</sub> =0V)	V <sub>SD</sub>	—	-0.7	-1	V
Input Capacitance 输入电容 (V <sub>GS</sub> =0V, V <sub>DS</sub> = -15V,f=1MHz)	C <sub>ISS</sub>	—	1004	—	pF
Common Source Output Capacitance 共源输出电容(V <sub>GS</sub> =0V, V <sub>DS</sub> = -15V,f=1MHz)	C <sub>OSS</sub>	—	204	—	pF
Reverse Transfer Capacitance 反馈电容(V <sub>GS</sub> =0V, V <sub>DS</sub> = -15V,f=1MHz)	C <sub>RSS</sub>	—	154	—	pF
Total Gate Charge 棚极电荷密度 (V <sub>DS</sub> = -15V, I <sub>D</sub> = -8.9A, V <sub>GS</sub> = -10V)	Q <sub>g</sub>	—	20	—	nC
Gate Source Charge 棚源电荷密度 (V <sub>DS</sub> = -15V, I <sub>D</sub> = -8.9A, V <sub>GS</sub> = -4.5V)	Q <sub>gs</sub>	—	3.8	—	nC
Gate Drain Charge 棚漏电荷密度 (V <sub>DS</sub> = -15V, I <sub>D</sub> = -8.9A, V <sub>GS</sub> = -4.5V)	Q <sub>gd</sub>	—	5.7	—	nC
Turn-ON Delay Time 开启延迟时间 (V <sub>DS</sub> = -15V I <sub>D</sub> = -1A, R <sub>GEN</sub> =6 Ω, V <sub>GS</sub> = -10V)	t <sub>d(on)</sub>	—	8.8	—	ns
Turn-ON Rise Time 开启上升时间 (V <sub>DS</sub> = -15V I <sub>D</sub> = -1A, R <sub>GEN</sub> =6 Ω, V <sub>GS</sub> = -10V)	t <sub>r</sub>	—	10.4	—	ns
Turn-OFF Delay Time 关断延迟时间 (V <sub>DS</sub> = -15V I <sub>D</sub> = -1A, R <sub>GEN</sub> =6 Ω, V <sub>GS</sub> = -10V)	t <sub>d(off)</sub>	—	35.2	—	ns
Turn-OFF Fall Time 关断下降时间 (V <sub>DS</sub> = -15V I <sub>D</sub> = -1A, R <sub>GEN</sub> =6 Ω, V <sub>GS</sub> = -10V)	t <sub>f</sub>	—	46.8	—	ns

■ Typical Characteristic Curve 典型特性曲线

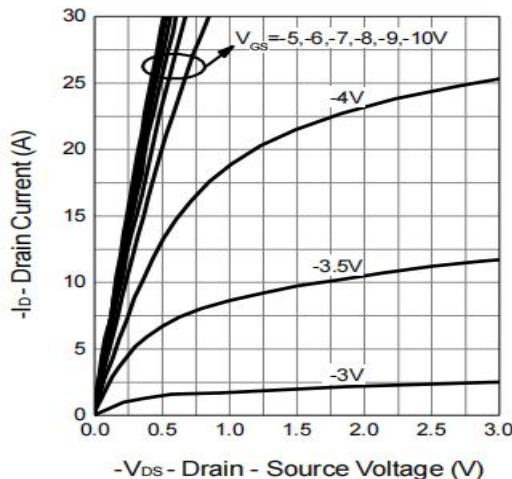


Figure 1: Output Characteristics

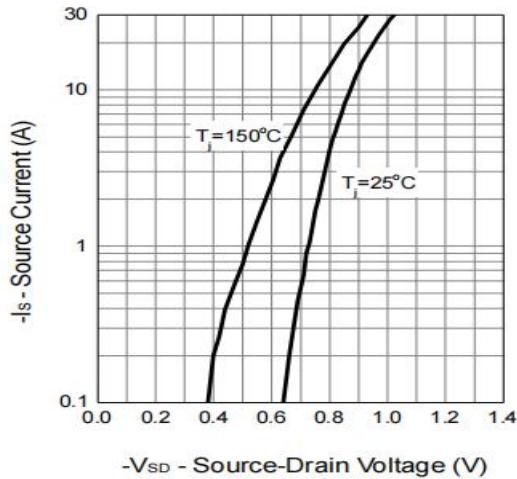


Figure 2: Diode Forward Characteristics

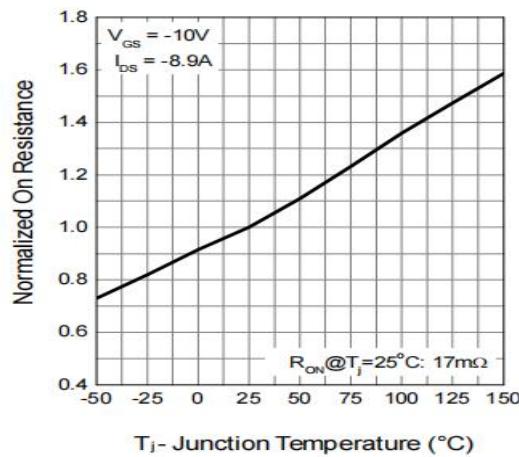


Figure 3: On-Resistance vs.  $T_J$

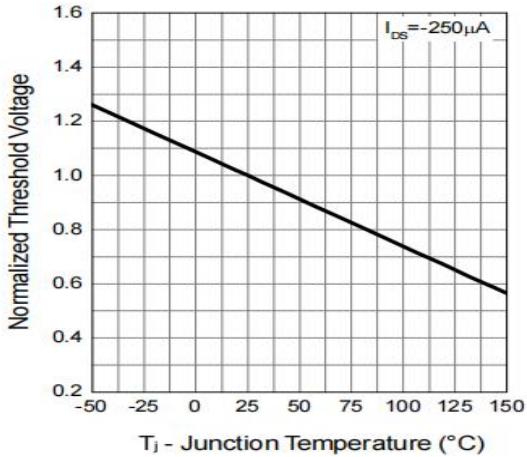


Figure 4: Gate Threshold Voltage

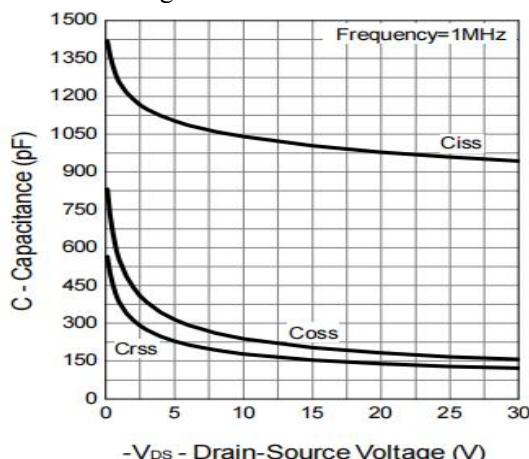


Figure 5: Capacitance Characteristics

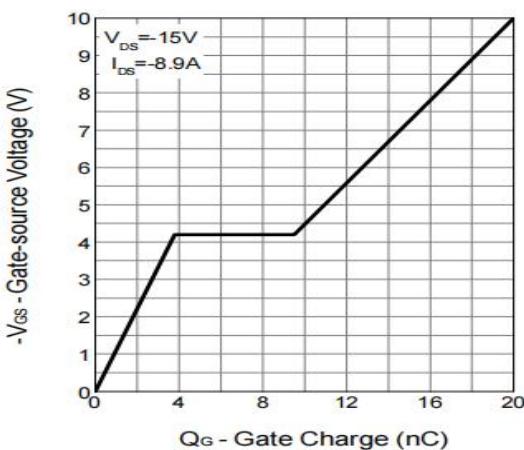


Figure 6: Gate-Charge Characteristics

■ P Typical Characteristic Curve 典型特性曲线

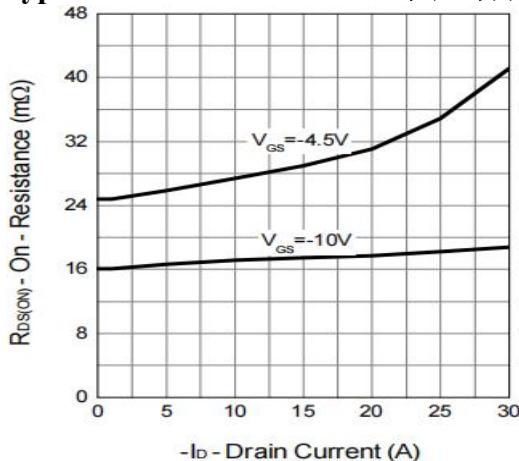


Figure 7: On-Resistance vs. Drain Current

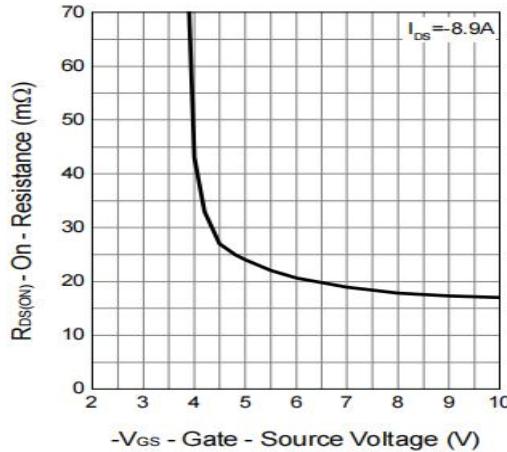


Figure 8: On-Resistance vs. V<sub>GS</sub>

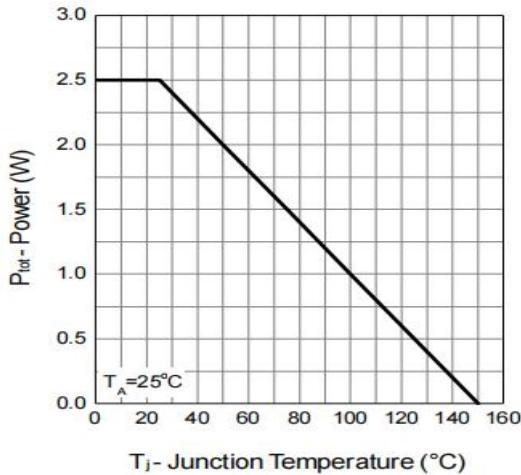


Figure 9: Power Rating Curve

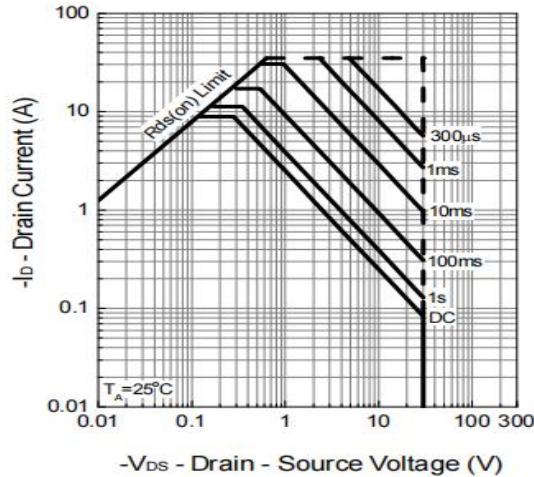


Figure 10: Safe Operating Area

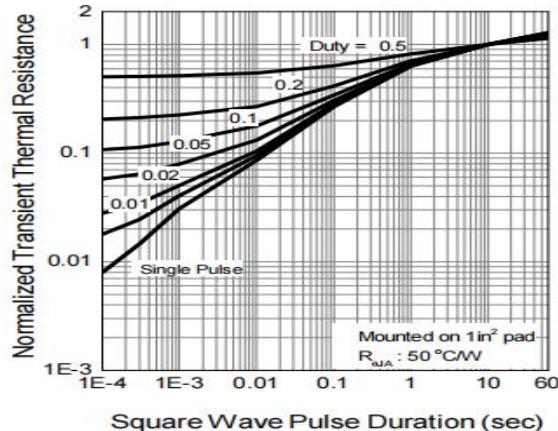
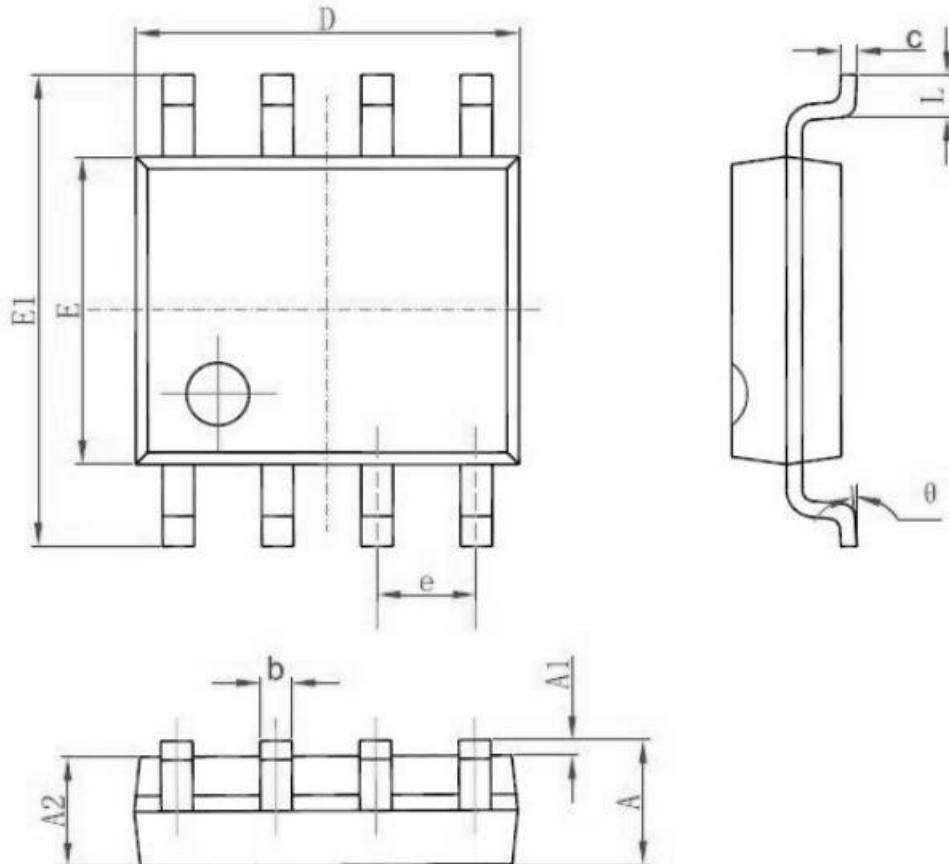


Figure 11: Transient Thermal Response Curve

## ■ Dimension 外形封装尺寸



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°